

### **85V N-Channel Power MOSFET**

### **Description**

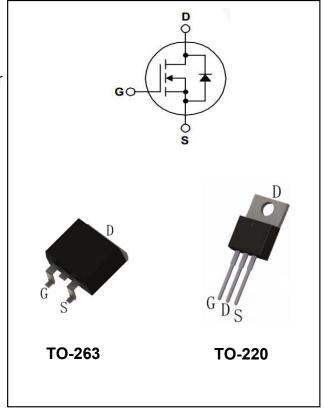
MPT180N08,the N-channel Enhanced Power MOSFETs, is obtained by advanced double trench technology which reduce the conduction loss,improve switching performance and enhance the avalanche energy. This is suitable device for BMS and high current switching applications.

#### **General Features**

- (1)  $V_{DS}$ =85V,  $R_{dson}$ <4m $\Omega$  @ $V_{GS}$ =10V,  $I_{D}$ =185A (Typ:3m $\Omega$ )
- (2) Fast Switching
- ③ Low On-Resistance (RDS(on)≤4mΩ)
- 4 Low Gate Charge
- 5 Low Reverse transfer capacitances
- 6 High avalanche ruggedness
- 7 RoHS product

## **Application**

- 1 BMS
- 2 Motor drivers



## **Package Marking And Ordering Information:**

Ordering Codes	Package	Product Code	Packing
MPT180N08-P	TO-220	MPT180N08P	Tube
MPT180N08-S	TO-263	MPT180N08S	Tape Reel

## ABSOLUTE RATINGS at Tc=25°C, unless otherwise specified

Symbol	Parameter	Rating	Units
V <sub>DSS</sub>	Drain-Source Voltage	85	V
	Continuous Drain Current, Silicon Limited	185	А
I <sub>D</sub>	Continuous Drain Current, Package Limited		А
	Continuous Drain Current @T <sub>C</sub> =100°C, Silicon Limited	117.2	А
I <sub>DM</sub> Note1	Pulsed Drain Current	480	А
V <sub>GS</sub>	Gate-Source Voltage	±20	V
E <sub>AS</sub> Note2	Avalanche Energy	240.2	mJ

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D	Power Dissipation  Derating Factor above 25°C		W
PD			W/°C
T <sub>J</sub> , T <sub>stg</sub>	Operating Junction and Storage Temperature Range	150, -55 to 150	℃
TL	Maximum Temperature for Soldering	260	°C

Note1: Repetitive Rating: Pulse width limited by maximum junction temperature Note2: L=0.5mH, las=35A, Start  $T_J$ =25°C

## **Thermal characteristics**

Symbol	Symbol Parameter		Units
$R_{\theta JC}$	thermal resistance, Junction-Case	0.5	°C/W
R <sub>0JA</sub>	thermal resistance, Junction-Ambient	62.5	°C/W

# Electrical Characteristics at Tc=25°C, unless otherwise specified

OFF Characteristics						
Symbol	Parameter	Test Conditions	,	Values		
	Parameter	rest conditions	Min	Тур	Max	Units
$V_{\text{DSS}}$	Drain-Source Breakdown Voltage	V <sub>GS</sub> =0V, I <sub>D</sub> =250μA	85	95		V
		V <sub>DS</sub> =100V, V <sub>GS</sub> =0V			1	μΑ
I <sub>DSS</sub>	Drain-Source Leakage Current	V <sub>DS</sub> =80V, V <sub>GS</sub> =0V @T <sub>C</sub> =125°C			100	μΑ
I <sub>GSS(F)</sub>	Gate-Source Forward Leakage	V <sub>GS</sub> =+20V			100	nA
I <sub>GSS(R)</sub>	Gate-Source Reverse Leakage	V <sub>GS</sub> =-20V			-100	nA

### **ON Characteristics**

Symbol	Parameter	Test Conditions		Values		
Symbol	raiametei	rest conditions	Min	Тур	Max	Units
R <sub>DS(on)</sub>	Drain-Source On-Resistance	V <sub>GS</sub> =10V, I <sub>D</sub> =50A		3	4	$\mathbf{m}$ Ω
V <sub>GS(th)</sub>	Gate Threshold Voltage	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250μA	2.0	3.0	4.0	V

Pulse width tp≤300μs, δ≤2%

### **Dynamic Characteristics**

Symbol	Parameter	Test Conditions	,	Values		
		rest conditions	Min	Тур	Max	Units
C <sub>iss</sub>	Input Capacitance	V <sub>DS</sub> =42.5V, V <sub>GS</sub> =0,		6234		
Coss	Output Capacitance	f=1MHz		1181		pF
C <sub>rss</sub>	Reverse Transfer Capacitance			97		
Qg	Total Gate Charge	Vpp=42.5V_lp=50A		124		

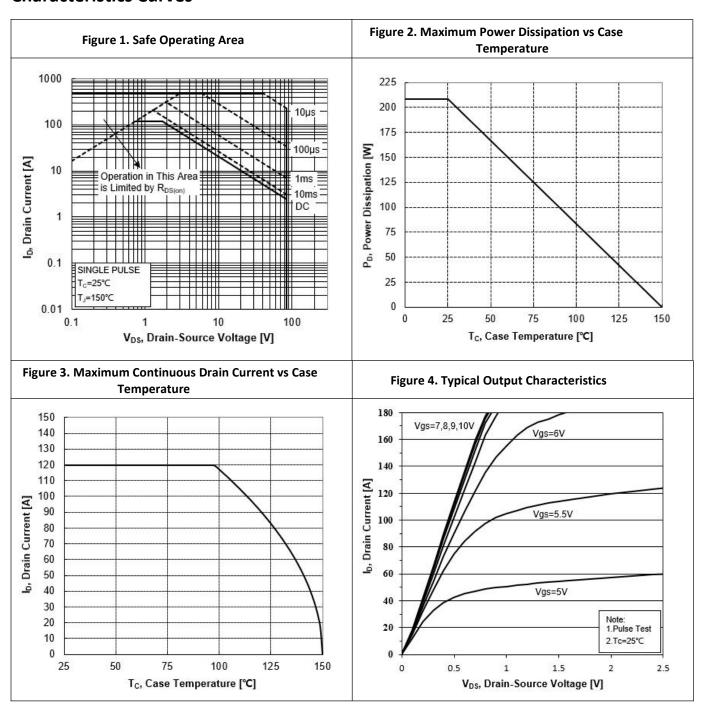
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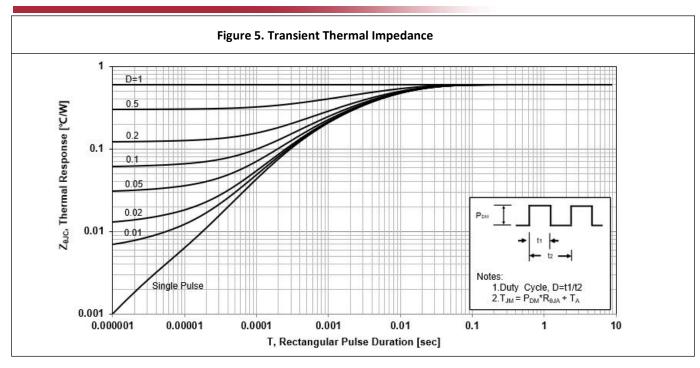
$Q_{gs}$	Gate-Source charge			31.2		
$Q_{gd}$	Gate-Drain charge			39.2		
Switching	Characteristics					
Symbol	Daramotor	Test Conditions	,	Values		
Symbol	Parameter	rest conditions	Min	Тур	Max	Units
t <sub>d(on)</sub>	Turn-On Delay Time			41		
t <sub>r</sub>	Rise Time	$V_{DD}$ =42.5V, $I_{D}$ =10A, $V_{GS}$ =10V, $R_{G}$ =3 $\Omega$ , Resistive Load		68		- ns
t <sub>d( off)</sub>	Turn-Off Delay Time			76		
t <sub>f</sub>	Fall Time			44		
Source-Dra	ain Diode Characteristics	·				
Comple al	Dougenetes	Took Conditions	- Values			l laita
Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Is	Continuous Source Current				120	Α
I <sub>SM</sub>	Maximum Pulsed Current				480	Α
V <sub>SD</sub>	Diode Forward Voltage	V <sub>GS</sub> =0V, I <sub>S</sub> =50A			1.2	V
T <sub>rr</sub>	Reverse Recovery Time	I <sub>s</sub> =30A,		80		ns
Q <sub>rr</sub>	Reverse Recovery Charge	di/dt=100A/us		112		uC

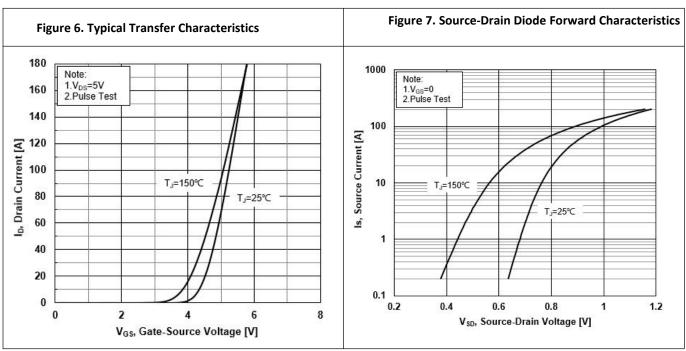


### **Characteristics Curves**

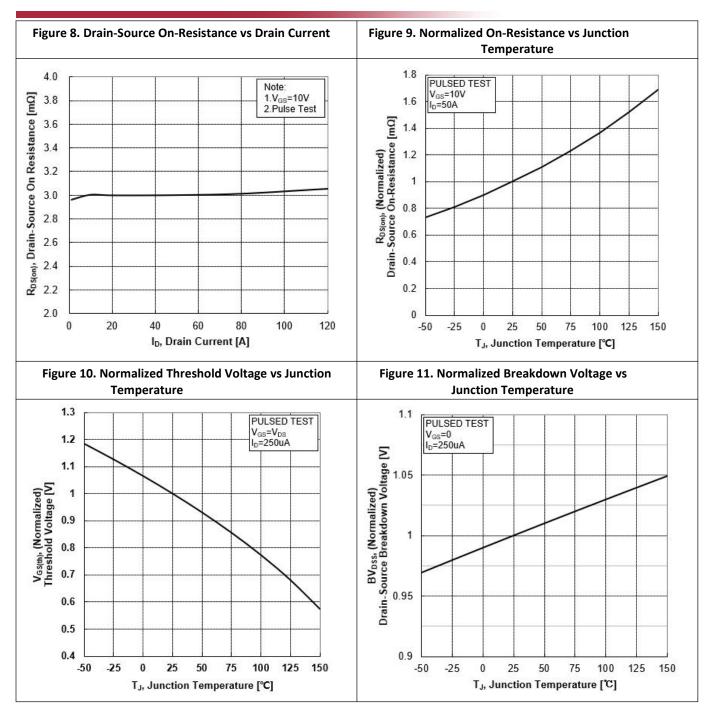




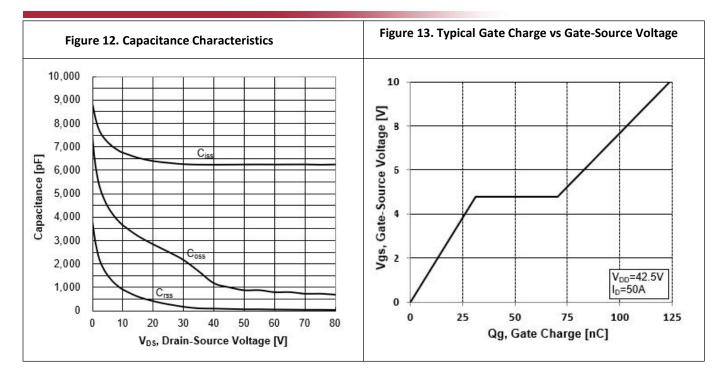






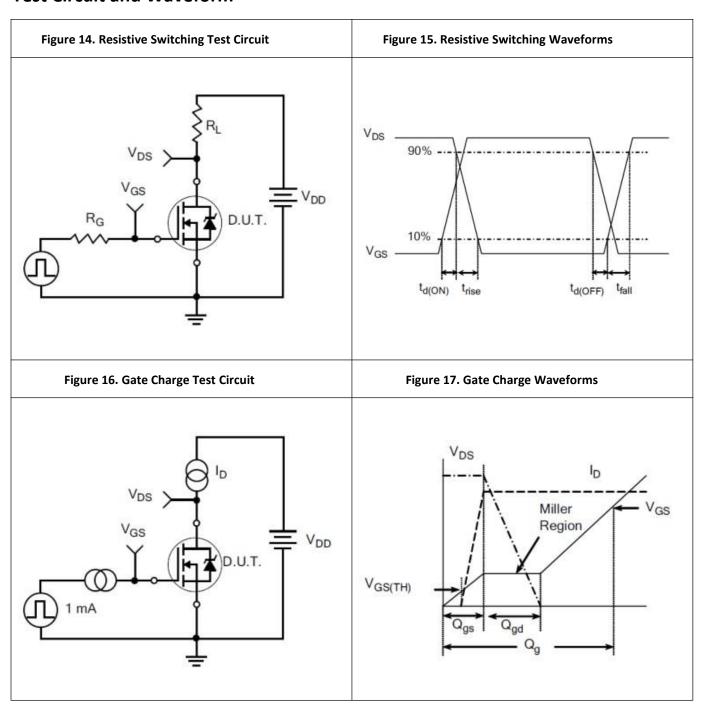




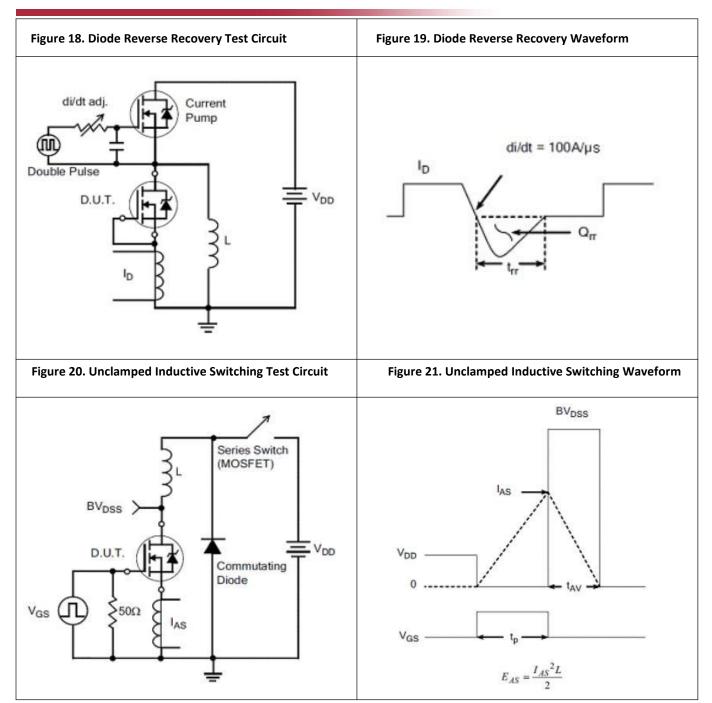




### **Test Circuit and Waveform**

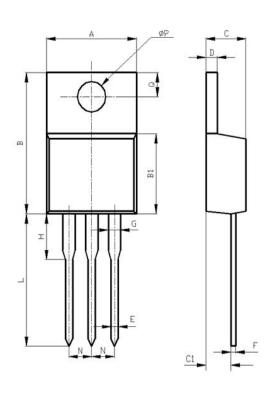








# **Package Description**

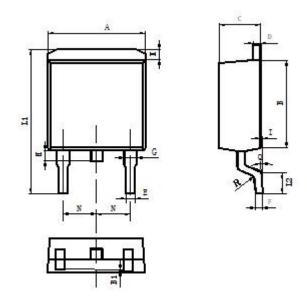


Items	Values(mm)			
items	MIN	MAX		
A	9.60	10.6		
В	15.0	16.0		
B1	8.90	9.50		
С	4.30	4.80		
C1	2.30	3.10		
D	1.20	1.40		
E	0.70	0.90		
F	0.30	0.60		
G	1.17	1.37		
Н	2.70	3.80		
L	12.6	14.8		
N	2.34	2.74		
Q	2.40	3.00		
фР	3.50	3.90		

TO-220 Package







Items	Values(mm)			
items	MIN	MAX		
A	9.80	10.40		
В	8.90	9.50		
B1	0	0.10		
С	4.40	4.80		
D	1.16	1.37		
Е	0.70	0.95		
F	0.30	0.60		
G	1.07	1.47		
Н	1.30	1.80		
K	0.95	1.37		
L1	14.50	16.50		
L2	1.60	2.30		
I	0	0.2		
Q	0°	8°		
R		0.4		
N	2.39	2.69		

TO-263 Package



#### NOTE:

- 1. Exceeding the maximum ratings of the device in performance may cause damage to the device, even the permanent failure, which may affect the dependability of the machine. Please do not exceed the absolute maximum ratings of the device when circuit designing.
- 2. When installing the heat sink, please pay attention to the torsional moment and the smoothness of the heat sink.
- **3.** MOSFETs is the device which is sensitive to the static electricity, it is necessary to protect the device from being damaged by the static electricity when using it.
- 4. Shenzhen Minos reserves the right to make changes in this specification sheet and is subject to change without prior notice.

#### **CONTACT:**

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